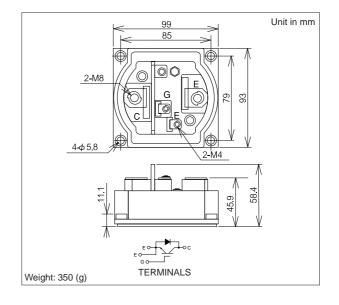
# MBN400C20

Silicon N-channel IGBT

OUTLINE DRAWING

#### FEATURES

- \* High thermal fatigue durability. (delta Tc=70°C,N>20,000cycles)
- \* low noise due to built-in free-wheeling diode - ultra soft fast recovery diode(USFD).
- \*High speed, low loss IGBT module.
- \*Low driving power due to low input capacitance MOS gate.
- \*High reliability, high durability module.
- \* Isolated head sink (terminal to base).



#### ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

Item		Symbol	Unit	MBN400C20		
Collector Emitter Volta	age	V <sub>CES</sub>	V	2,000		
Gate Emitter Voltage		V <sub>GES</sub>	V	±20		
Collector Current	DC	lc	A	400		
	1ms	I <sub>Cp</sub>	~	800		
Forward Current	DC	IF	^	400		
	1ms	I <sub>FM</sub>	A –	800		
Collector Power Dissipation		Pc	W	3,000		
Junction Temperature	•	Tj	°C	-40 ~ +125		
Storage Temperature		T <sub>stg</sub>	°C	-40 ~ +125		
Isolation Voltage		V <sub>ISO</sub>	V <sub>RMS</sub>	4,000(AC 1 minute)		
Screw Torque	Terminals(M4/M8)	-	N.m	2/10 (1)		
	Mounting(M5)	-		2.8 (2)		

Notes: (1)Recommended Value 1.8±0.2/9±1N.m

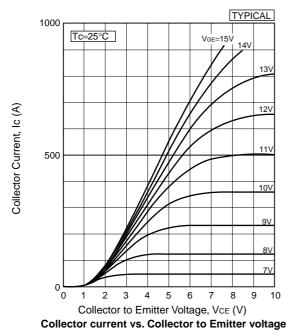
(2)Recommended Value 2.6±0.2N.m

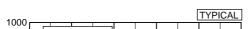
#### CHARACTERISTICS (Tc=25°C)

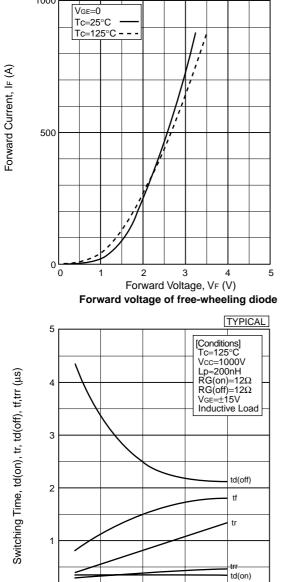
Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I <sub>CES</sub>	mA	-	-	4.0	V <sub>CE</sub> =2,000V,V <sub>GE</sub> =0V
Gate Emitter Leakage Current		I <sub>GES</sub>	nA	-	-	±200	V <sub>GE</sub> =±20V,V <sub>CE</sub> =0V
Collector Emitter Saturation Voltage		V <sub>CE(sat)</sub>	V	-	4.2	5.2	I <sub>C</sub> =400A,V <sub>GE</sub> =15V
Gate Emitter Threshold Voltage		V <sub>GE(TO)</sub>	V	4.0	5.1	7.0	V <sub>CE</sub> =10V, I <sub>C</sub> =400mA
Input Capacitance		Cies	nF	-	46	100	V <sub>CE</sub> =10V,V <sub>GE</sub> =0V,f=100KHz
Switching Times	Rise Time	tr		-	1.4	2.3	V <sub>CC</sub> =1,000V,Ic=400A
	Turn On Time	t <sub>on</sub>	μS	-	1.7	2.6	L=200nH
	Fall Time	t <sub>f</sub>		-	1.8	2.4	$R_G=12\Omega$ (3)
	Turn Off Time	t <sub>off</sub>		-	4.0	5.9	V <sub>GE</sub> =±15V Tc=125°C
Peak Forward Voltage Drop		V <sub>FM</sub>	V	-	2.4	3.4	-Ic=400A,V <sub>GE</sub> =0V
Reverse Recovery Time		t <sub>rr</sub>	μs	-	0.5	0.9	Vcc=1,000V,-lc=400A,L=200nH, Tc=125°C (4)
Thermal Impedance	IGBT	Rth(j-c)	°C/W	-	-	0.033	Junction to case
	FWD	Rth(j-c)		-	-	0.10	

Notes:(3) R<sub>G</sub> value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable R<sub>G</sub> value after the measurement of switching waveforms (overshoot voltage,etc.)with appliance mounted.

(4) Counter arm IGBT V<sub>GE</sub>=-15V







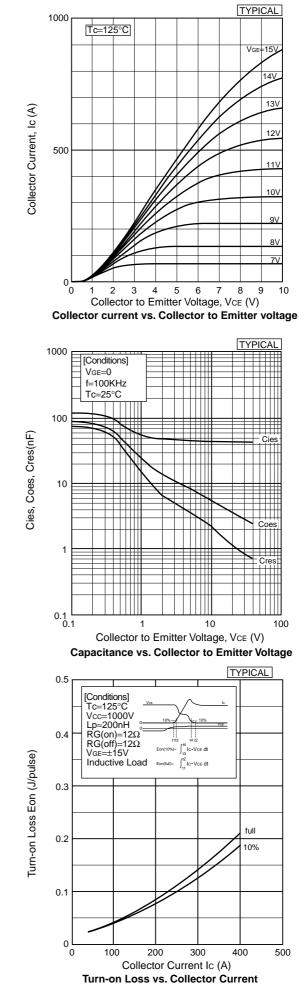
0 200 300 Collector Current, Ic(A)

Switching time vs. Collector current

0

0

100

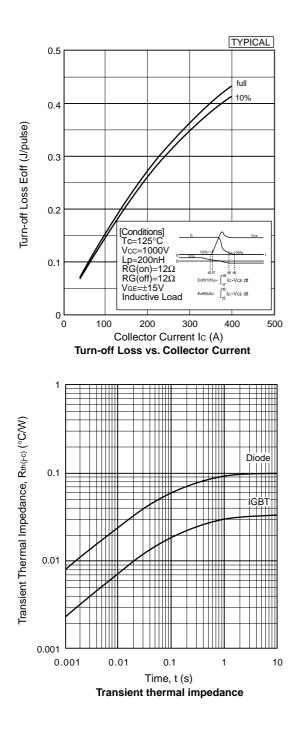


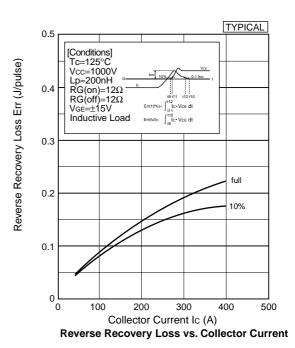
**HITACHI** 

500

400

PDE-N400C20-0





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## **HITACHI POWER SEMICONDUCTORS**

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